

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Power Resistor for Mounting onto a Heatsink Thick Film Technology

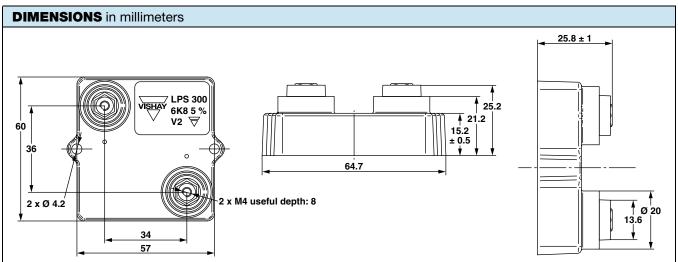


FEATURES

- 300 W at 85 °C bottom case temperature
- Wide resistance range: 0.3 Ω to 900 k Ω E24 series



- Non inductive
- · Easy mounting
- · Low thermal radiation of the case
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



Note

• Tolerances unless stated: ± 0.2 mm

STANDARD ELECTRICAL SPECIFICATIONS						
MODEL	RESISTANCE RANGE Ω	RATED POWER P _{85 °C} W	LIMITING ELEMENT VOLTAGE U _L V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C	CRITICAL RESISTANCE (Ω)
LPS 300	0.3 to 900K	300	5K	1, 2, 5, 10	150, 300, 500	83.33K

MECHANICAL SPECIFICATIONS			
Mechanical Protection	Insulated case UL 94 V-0		
Resistive Element	Thick film		
Substrate	Alumina		
End Connections	Screws M4		
Tightening Torque Connections	2 Nm		
Tightening Torque Heatsink	2 Nm		
Maximum Torque	2.5 Nm		
Weight	83 g ± 10 %		

ENVIRONMENTAL SPECIFICATIONS			
Temperature Range	- 55 °C to 120 °C		
Climatic Category	55/120/56		

TECHNICAL SPECIFICATIONS			
Power Rating and Thermal Resistance	300 W at + 85 °C bottom case temperature R _{TH (j - c)} : 0.112 °C/W		
Temperature Coefficient - 55 °C/120 °C IEC 60115-1 Standard	$R \le 1 \ \Omega$: $\pm 500 \ ppm/^{\circ}C$ 1 $\Omega < R \le 10 \ \Omega$: $\pm 300 \ ppm/^{\circ}C$ 10 $\Omega < R$: $\pm 150 \ ppm/^{\circ}C$		
Dielectric Strength IEC 60115-1, 1 min, 10 mA max.	7 kV _{RMS} or 12 kV _{RMS}		
Lightning test 1.2/50 μs IEC 61000-4-5	Until 12 kV		
Insulation Resistance	$\geq 10^4~M\Omega$		
Inductance	≤ 0.1 µH		

Vishay Sfernice

PERFORMANCE				
TESTS	CONDITIONS	REQUIREMENTS		
Momentary Overload	IEC 60115-1 4 x P _r /10 s U _{max.} ≤ U _L = 5000 V	$\pm (0.25 \% + 0.05 \Omega)$		
Rapid Temperature Change	IEC 60115-1/IEC 30068-2-14 Test Na 50 cycles - 55 °C to + 120 °C	± (0.5 % + 0.05 Ω)		
Load Life	IEC 60115-1 1000 h (90/30) P _r at 85 °C	± (0.5 % + 0.05 Ω)		
Humidity (Steady State)	IEC 60115-1 56 days RH 95 %/40 °C	± (0.5 % + 0.05 Ω)		
Vibration	MIL STD 202 method 204 cond. D (10 g; 5/500 Hz)	$\pm (0.25 \% + 0.05 \Omega)$		
Climatic Sequence	IEC 60115-1 (55/120/56)	± (1 % + 0.05 Ω)		

RECOMMENDATIONS FOR MOUNTING ONTO A HEATSINK

- · Surfaces in contact must be carefully cleaned.
- The heatsink must have an acceptable flatness: From 0.05 mm to 0.1 mm/100 mm.
- Roughness of the heatsink must be around 6.3 µm. In order to improve thermal conductivity, surfaces in contact (alumina, heatsink) should be coated with a silicone grease (type SI 340 from Rhône-Poulenc or Dow 340 from Dow Corning) or a thermal film (type Q Pad II) easier and faster to install than the grease.
- The fastening of the resistor to the heatsink is under pressure control of two screws tightened at 2 Nm for full power availability.

Tightening Torque on Heatsink	LPS 300		
Tightening Torque on Heatsink	2 Nm		

- The following accessories are supplied with each product:
 - 2 screws CHC M4 x 25 class 8.8 and 2 M4 contact lock washers for heatsink mounting
 - 2 screws TH M4 x 6/6 and 2 M4 contact lock washers for connections. 2 off CHC M4 x 16/16 class 8.

CHOICE OF THE HEATSINK

The user must choose the heatsink according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 120 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{R_{TH (j-c)} + R_{TH (c-h)} + R_{TH (h-a)}}$$

P: Expressed in W

ΔT: Difference between maximum working temperature and room temperature

 $R_{TH (j-c)}$: Thermal resistance value measured between resistive layer and outer side of the resistor.

It is the thermal resistance of the component: (see specifications environmental paragraph).

R_{TH (c - h)}: Thermal resistance value measured between outer side of the resistor and upper side of the heatsink.

This is the thermal resistance of the interface (grease, thermal pad), and the quality of the fastening device.

R_{TH (h - a)}: Thermal resistance of the heatsink.

Example:

R_{TH (c - a)} for LPS 300 power dissipation 180 W at + 50 °C room temperature.

$$\Delta T \leq$$
 120 °C - 50 °C = 70 °C

$$R_{TH (j-c)} + R_{TH (c-h)} + R_{TH (h-a)} = \frac{\Delta T}{P} = \frac{70}{180} = 0.388 \text{ °C/W}$$

 $R_{TH (i - c)} = 0.112 \text{ °C/W}$

 $R_{TH (c-h)} + R_{TH (h-a)} = 0.388 \text{ °C/W} - 0.112 \text{ °C/W} = 0.276 \text{ °C/W}$



Vishay Sfernice

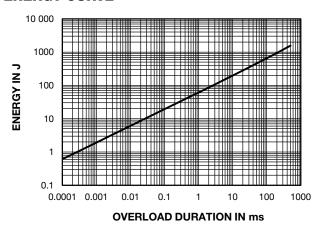
OVERLOADS

In any case the applied voltage must be lower than $U_1 = 5000 \text{ V}$.

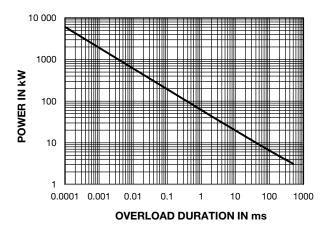
Short time overload: 4 x P_r/10 s

Accidental overload: The values indicated on the following graph are applicable to resistors in air or mounted onto a heatsink.

ENERGY CURVE



POWER CURVE



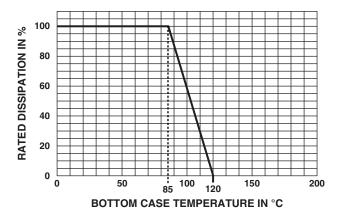
MARKING

Series, style, ohmic value (in Ω), tolerance (in %), manufacturing date, Vishay Sfernice trademark.

POWER RATING

The temperature of the case should be maintained within the limits specified in the following figure.

To optimize the thermal conduction, contacting surfaces should be coated with silicone grease or thermal film, and heatsink mounting screws tightened to 2 Nm.



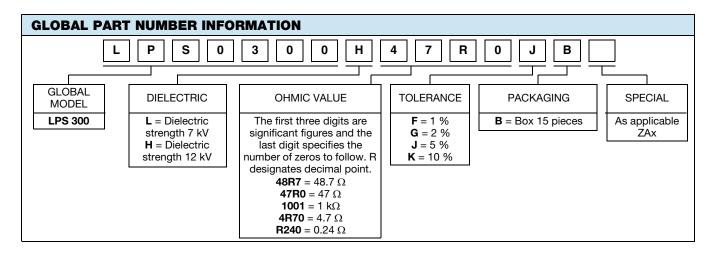
PACKAGING

Box of 15 units



Vishay Sfernice

ORDERING INFORMATION							
LPS	300	100 kΩ	± 1 %	XXX	BO15	е	
MODEL	STYLE	RESISTANCE VALUE	TOLERANCE	CUSTOM DESIGN	PACKAGING	LEAD (Pb)-FREE	
			± 1 %	Optional			
			± 2 %	on request:			
			± 5 %	Special TCR,			
			± 10 %	shape etc.			





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000